

RENESAS FemtoClock® Crystal-to-3.3V LVPECL Frequency Synthesizer

DATASHEET

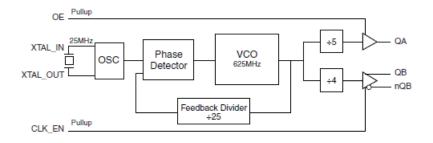
GENERAL DESCRIPTION

The 8430252I-45 is a 2 output LVPECL and LVCMOS/LVTTL Synthesizer optimized to generate Ethernet reference clock frequencies. Using a 25MHz, 18pF parallel resonant crystal, the following fre-quencies can be generated: 156.25MHz LVPECL output and, 125MHz LVCMOS output. The 8430252I-45 uses IDT's 3RD generation low phase noise VCO technology and can achieve 1ps or lower typical rms phase jitter, easily meeting Ethernet jitter requirements. The 8430252I-45 is packaged in a small 16-pin TSSOP package.

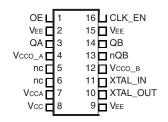
FEATURES

- · One differential 3.3V LVPECL output and One LVCMOS/LVTTL output
- · Crystal oscillator interface designed for a 25MHz, 18pF parallel resonant crystal
- · A 25MHz crystal generates both an output frequency of 156.25MHz (LVPECL) and 125MHz (LVCMOS)
- VCO frequency: 625MHz
- RMS phase jitter @ 156.25MHz (1.875MHz 20MHz) using a 25MHz crystal: 0.39ps (typical)
- Full 3.3V supply mode
- -40°C to 85°C ambient operating temperature
- · Available in lead-free (RoHS 6) package

BLOCK DIAGRAM



PIN ASSIGNMENT



8430252I-45 16-Lead TSSOP 4.4mm x 5.0mm x 0.92mm package body G Package Top View



TABLE 1. PIN DESCRIPTIONS

Number	Name	Ту	/pe	Description
1	OE	Input	Pullup	Output enable pin. LVCMOS/LVTTL interface levels. See Table 3A Function Table.
2, 9, 15	V	Power		Negative supply pins.
3	QA	Output		LVCMOS/LVTTL clock output.
4	V _{CCO_A}	Power		Output supply pin for QA output.
5, 6	nc	Unused		No connect.
7	V _{CCA}	Power		Analog supply pin.
8	V _{cc}	Power		Core supply pin.
10, 11	XTAL_OUT, XTAL_IN	Input		Crystal oscillator interface. XTAL_IN is the input, XTAL_OUT is the output.
12	V _{CCO_B}	Power		Output supply pin for QB, nQB outputs.
13, 14	nQB, QB	Output		Differential clock outputs. LVPECL interface levels.
16	CLK_EN	Input	Pullup	Clock enable pin. LVCMOS/LVTTL interface levels. See Table 3B Function Table.

NOTE: Pullup refers to internal input resistors. See Table 2, Pin Characterisitcs, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance				4		pF
C _{PD}	Power Dissipation Capacita	ance	V_{CC} , V_{CCA} , V_{CCO_A} , V_{CCO_B} = 3.465V		18		pF
R	Input Pullup Resistor				51		kΩ
R _{out}	Output Impedance	QA	V _{CCO_A} = 3.3V		20		Ω

TABLE 3A. OE SELECT FUNCTION TABLE

Input	Output
OE	QA
0	Hi-Z
1	Active

TABLE 3B. CLK_EN SELECT FUNCTION TABLE

Input	Outputs			
CLK_EN	QB	nQB		
0	Low	High		
1	Active	Active		



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{cc} 4.6V

Inputs, V_{cc} -0.5V to V_{cc} + 0.5V

Outputs, I

Continuous Current 50mA Surge Current 100mA

Package Thermal Impedance, $\theta_{_{\rm JA}}$ 89°C/W (0 lfpm) Storage Temperature, T $_{_{\rm STG}}$ -65°C to 150°C NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{cc} = V_{cca} = V_{cco_A}, V_{cco_B} = 3.3V \pm 5\%, T_{A} = -40^{\circ}\text{C}$ to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{cc}	Core Supply Voltage		3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage		V _{cc} - 0.10	3.3	V _{cc}	V
V _{CCO A} , V _{CCO B}	Output Supply Voltage		3.135	3.3	3.465	V
 EE	Power Supply Current				95	mA
CCA	Analog Supply Current				10	mA

Table 4B. LVCMOS / LVTTL DC Characteristics, $V_{cc} = V_{cca} = V_{cca} = 3.3V \pm 5\%$, $T_{a} = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage			2		V _{cc} + 0.3	V
V _{IL}	Input Low Voltage			-0.3		0.8	V
I _{IH}	Input High Current	OE, CLK_EN	$V_{CC} = V_{IN} = 3.465V$			5	
I _"	Input Low Current	OE, CLK_EN	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			
V	Output High Voltage; NOTE 1			2.6			V
V _{OL}	Output Low Voltage; I	NOTE 1				0.5	V

NOTE 1: Outputs terminated with 50Ω to V_{CCO} /2. See Parameter Measurement Information Section,

Table 4C. LVPECL DC Characteristics, $V_{cc} = V_{cca} = V_{cca_B} = 3.3V \pm 5\%$, $T_{a} = -40$ °C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		V _{CCO_B} - 1.4		V _{cco_B} - 0.9	V
V _{OL}	Output Low Voltage; NOTE 1		V _{cco_B} - 2.0		V _{CCO_B} - 1.7	V
V	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Outputs terminated with 50 Ω to V $_{_{\text{CCO}}}$ - 2V.

[&]quot;3.3V Output Load Test Circuit".



TABLE 5. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		F	Fundamental		
Frequency			25		MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

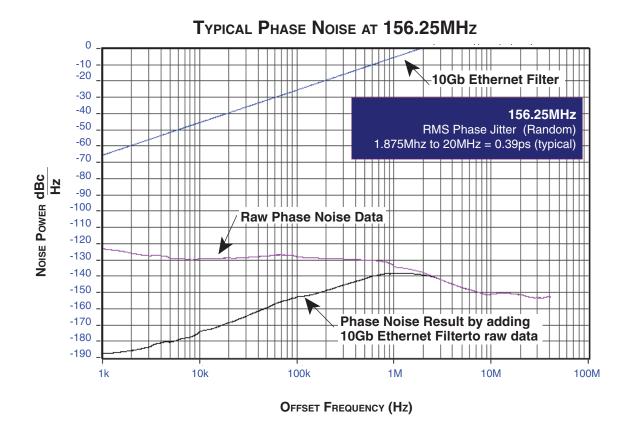
NOTE: Characterized using an 18pF parallel resonant crystal.

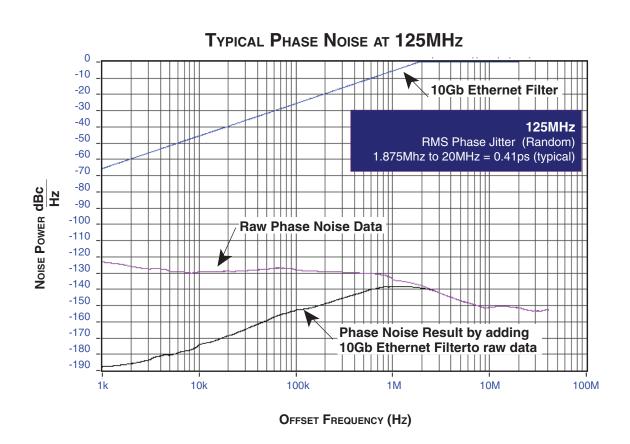
Table 6. AC Characteristics, $V_{cc} = V_{cca} = V_{cco_A}, V_{cco_B} = 3.3V \pm 5\%, T_{A} = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency B	ango			156.25		MHz
оит	Output Frequency Range				125		MHz
+ii+(<i>C</i> ()	RMS Phase Jitter	QA	125MHz (1.875MHz - 20MHz)		0.41		ps
tjit(Ø)	(Random); NOTE 1	QB, nQB	156.25MHz (1.875MHz - 20MHz)		0.39		ps
+ /+	Output	QA	20% to 80%	500		1200	ps
t _R /t _F	Rise/Fall Time	QB, nQB	20% 10 80%	300	125 0.41 0.39 12 70 5	700	ps
odc	Output Duty Cycle	QA		47		53	%
Jouc	Output Duty Cycle	QB, nQB		48		52	%

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

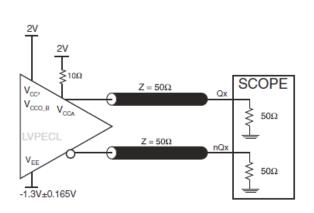
NOTE 1: Please refer to the Phase Noise Plots.

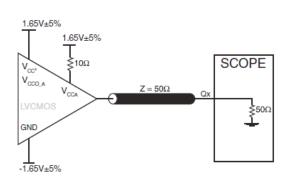




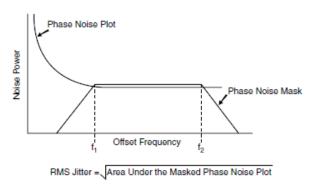


PARAMETER MEASUREMENT INFORMATION

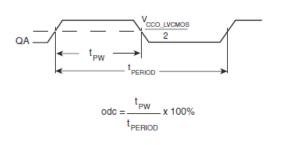




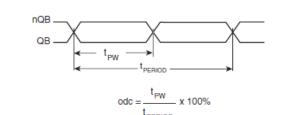
3.3V CORE/3.3V LVPECL OUTPUT LOAD AC TEST CIRCUIT



3.3V CORE/3.3V LVCMOS OUTPUT LOAD ACTEST CIRCUIT



RMS PHASE JITTER



LVCMOS OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



LVPECL OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



LVCMOS OUTPUT RISE/FALL TIME

LVPECL OUTPUT RISE/FALL TIME



APPLICATION INFORMATION

POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. To achieve optimum jitter performance, power supply isolation is required. The 8430252I-45 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{cc} , V_{ccA} , and V_{cco} , should be individually connected to the power supply plane through vias, and 0.01µF bypass capacitors should be used for each pin. Figure 1 illustrates this for a generic V_{cc} pin and also shows that V_{ccA} requires that an additional 10Ω resistor along with a $10\mu F$ bypass capacitor be connected to the V_{ccA} pin.

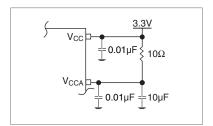


FIGURE 1. POWER SUPPLY FILTERING

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

SELECT PINS:

All select pins have internal pullups; additional resistance is not required but can be added for additional protection. A 1k $\!\Omega$ resistor can be used.

OUTPUTS:

LVCMOS OUTPUT:

All unused LVCMOS output can be left floating. We recommend that there is no trace attached.

LVPECL OUTPUT:

All unused LVPECL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

CRYSTAL INPUT INTERFACE

The 8430252I-45 has been characterized with 18pF parallel resonant crystals. The capacitor values shown in

Figure 2 below were determined using a 25MHz, 18pF parallel resonant crystal and were chosen to minimize the ppm error.

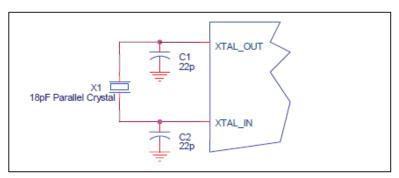


FIGURE 2. CRYSTAL INPUT INTERFACE



OVER-DRIVING THE CRYSTAL INTERFACE

The XTAL_IN input can a single-ended LVCMOS signal through an AC coupling capacitor. A general interface diagram is shown in *Figure 3A*. The XTAL_OUT pin can be left floating. The maximum amplitude of the input signal should not exceed 2V and the input edge rate can be as slow as 10ns. This configuration requires that the output impedance of the driver (Ro) plus the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the crystal input will attenuate the signal in half. This

can be done in one of two ways. First, R1 and R2 in parallel should equal the transmission line impedance. For most 50Ω applications, R1 and R2 can be $100\Omega.$ This can also be accomplished by removing R1 and making R2 $50\Omega.$ By overdring the crystal oscillator, the device will be functional, but note, the device performance is guaranteed by using a quartz crystal.

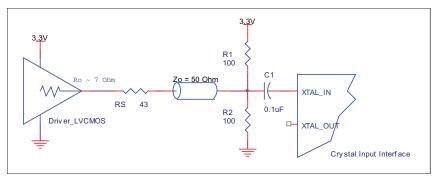


FIGURE 3A. GENERAL DIAGRAM FOR LVCMOS DRIVER TO XTAL INPUT INTERFACE

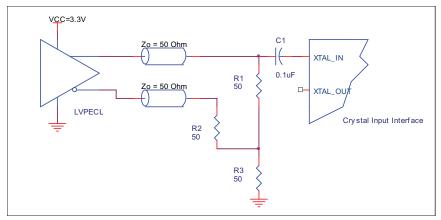


FIGURE 3B. GENERAL DIAGRAM FOR LVPECL DRIVER TO XTAL INPUT INTERFACE



TERMINATION FOR 3.3V LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

The differential outputs are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive 50Ω

transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 4A and 4B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

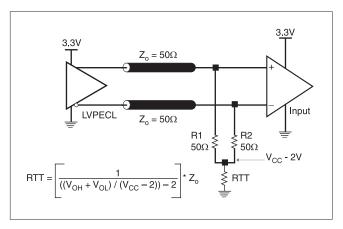


FIGURE 4A. LVPECL OUTPUT TERMINATION

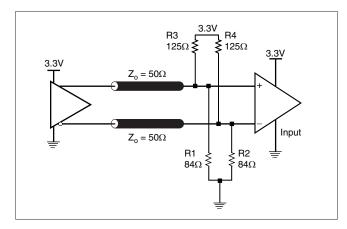


FIGURE 4B. LVPECL OUTPUT TERMINATION



LAYOUT GUIDELINE

Figure 5 shows an example of 8430252I-45 application schematic. In this example, the device is operated at $V_{cc} = 3.3V$. The 18pF parallel resonant 25MHz crystal is used. The C1 = 22pF and C2 = 22pF are recommended for frequency accuracy. For different board layout, the C1 and C2 may be slightly adjusted for optimizing

frequency accuracy. Two examples of LVPECL and one example of LVCMOS terminations are shown in this schematic. Additional termination approaches are shown in the LVPECL Termination Application Note.

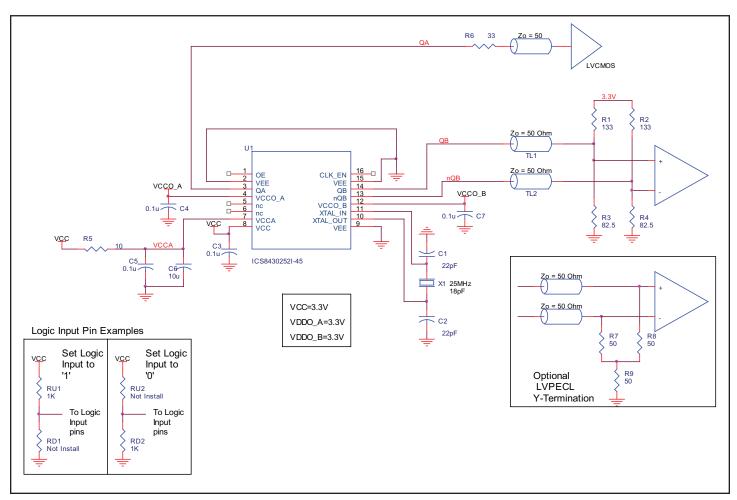


FIGURE 5. 8430252I-45 SCHEMATIC EXAMPLE



POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the 8430252I-45. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the 8430252I-45 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{cc} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{CC_MAX} * I_{EE_MAX} = 3.465V * 95mA = 329.17mW
 (95mA includes the LVCMOS output terminated with 50Ω to V_C/2 at 125MHz)
- Power (outputs)_{MAX} = 30mW/Loaded Output pair

Total Power $_{MAX}$ (3.465V, with all outputs switching) = 329.17mW + 30mW = 359.17mW

2. Junction Temperature.

Junction temperature at the junction of the bond wire and bond pad directly affects the reliability of the device. The maximum recommended junction temperature is 125°C. Limiting the internal transistor junction temperature, Tj, to 125°C ensures that the bond wire and bond pad temperature remains below 125°C.

The equation for Tj is as follows: Tj = θ_{JA} * Pd_total + T_A

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

 T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 81.8°C/W per Table 7 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is: $85^{\circ}\text{C} + 0.359\text{W} * 81.8^{\circ}\text{C/W} = 114.4^{\circ}\text{C}$. This is below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (multi-layer).

Table 7. Thermal Resistance θ_{JA} for 16-pin TSSOP, Forced Convection

θ_{JA} by Velocity (Linear Feet per Minute)

0200500Single-Layer PCB, JEDEC Standard Test Boards137.1°C/W118.2°C/W106.8°C/WMulti-Layer PCB, JEDEC Standard Test Boards89.0°C/W81.8°C/W78.1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



3. Calculations and Equations.

The purpose of this section is to calculate power dissipation on the IC per LVPECL output pair.

LVPECL output driver circuit and termination are shown in Figure 6.

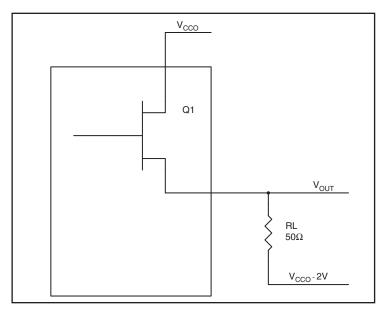


FIGURE 6. LVPECL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{\cos_8} – 2V.

• For logic high,
$$V_{OUT} = V_{OH_MAX} = V_{CCO_MAX} - 0.9V$$

$$(V_{CCO_MAX} - V_{OH_MAX}) = 0.9V$$

• For logic low, $V_{OUT} = V_{OL_MAX} = V_{CCO_MAX} - 1.7V$

$$(V_{CCO MAX} - V_{OL MAX}) = 1.7V$$

Pd_H is power dissipation when the output drives high.

$$Pd_H = [(V_{\text{OH_MAX}} - (V_{\text{CCO_MAX}} - 2V))/R_{\text{L}}] * (V_{\text{CCO_MAX}} - V_{\text{OH_MAX}}) = [(2V - (V_{\text{CCO_MAX}} - V_{\text{OH_MAX}}))/R_{\text{L}}] * (V_{\text{CCO_MAX}} - V_{\text{OH_MAX}}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd_{L} = [(V_{\text{OL_MAX}} - (V_{\text{CCO_MAX}} - 2V))/R_{\text{L}}] * (V_{\text{CCO_MAX}} - V_{\text{OL_MAX}}) = [(2V - (V_{\text{CCO_MAX}} - V_{\text{OL_MAX}}))/R_{\text{L}}] * (V_{\text{CCO_MAX}} - V_{\text{OL_MAX}}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = Pd_H + Pd_L = 30mW



RELIABILITY INFORMATION

Table 8. $\theta_{_{JA}} \text{vs. Air Flow Table for 16 Lead TSSOP}$

$\theta_{\text{\tiny JA}}$ by Velocity (Linear Feet per Minute)

0200500Single-Layer PCB, JEDEC Standard Test Boards137.1°C/W118.2°C/W106.8°C/WMulti-Layer PCB, JEDEC Standard Test Boards89.0°C/W81.8°C/W78.1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for 8430252I-45 is: 2070



PACKAGE OUTLINE AND DIMENSIONS

PACKAGE OUTLINE - G SUFFIX FOR 16 LEAD TSSOP

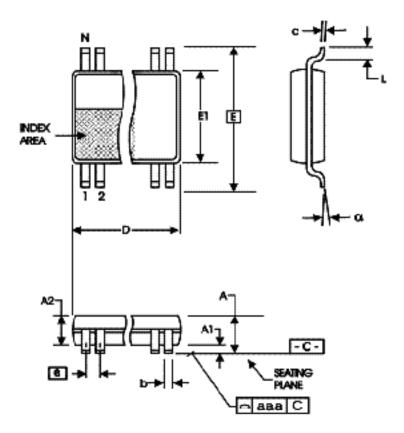


TABLE 9. PACKAGE DIMENSIONS

SYMBOL	Millim	neters	
STWIDOL	Minimum	Maximum	
N	1	6	
А		1.20	
A1	0.05	0.15	
A2	0.80	1.05	
b	0.19	0.30	
С	0.09	0.20	
D	4.90	5.10	
E	6.40 BASIC		
E1	4.30	4.50	
е	0.65 E	BASIC	
L	0.45	0.75	
α	0°	8°	
aaa		0.10	

Reference Document: JEDEC Publication 95, MO-153



TABLE 10. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8430252CGI-45LF	252Cl45L	16 Lead "Lead-Free" TSSOP	tube	-40°C to 85°C
8430252CGI-45LFT	252Cl45L	16 Lead "Lead-Free" TSSOP	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.



	REVISION HISTORY SHEET							
Rev	Table	Page	Description of Change	Date				
А	T6	4 7 8 9 15	AC Characteristics Table - added thermal note. Power Supply Filtering Techniques - updated text. Updated Over-Driving the Crystal Interface section. Termination for 3.3V LVPECL Outputs - updated Figures 4A and 4B. Ordering Information Table - deleted ICS prefix in Part/Order column. Added LF marking.	11/3/10				
В	T10	15	Ordering Information - removed leaded devices. Updated datasheet format.	12/9/14				



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